

Reply to Final Office Action of November 25, 2009

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1. (Currently Amended) A magnetic field molding device used in producing a ferrite sintered magnet, comprising:  
a die for compression-molding a molding slurry, wherein the slurry is produced by dispersing a powder mainly composed of ferrite in a dispersion medium and injected into the die,  
a magnetic field generating source for applying a magnetic field to the slurry within the die in a given direction, and  
a temperature control unit for controlling the temperature of the die, into which the molding slurry is injected, and the temperature of the molding slurry by heating the die,  
wherein the die is provided with a plurality of cavities for producing a plurality of molded bodies for a plurality of the ferrite sintered magnets, and  
wherein the die is provided with delivery paths for injecting the slurry into each of the cavities.
2. (Original) The magnetic field molding device according to claim 1, wherein the temperature control unit comprises a heater provided in the die for heating the die and a controller for controlling the heater.
3. (Currently Amended) [[he]] The magnetic field molding device according to claim 1, wherein the temperature control unit comprises a flow path provided in the die, a pump for sending a liquid medium into the flow path and a heat source for heating the liquid medium.

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4. (Original) The magnetic field molding device according to claim 2, wherein the temperature control unit controls the temperature of the die from 40 through 120°C.

5. (Original) The magnetic field molding device according to claim 2, wherein the temperature control unit controls the temperature of the die from 40 through 100°C.